# **Boca Semiconductor Corp.**

#### **MAXIMUM RATINGS**

Rating	Symbol	2N3019 2N3020	2N3700	Unit
Collector-Emitter Voltage	VCEO	80	80	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	140	140	Vdc
Emitter-Base Voltage	VEBO	7.0	7.0	Vdc
Collector Current — Continuous	lc	1.0	1.0	Adc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	PD	0.8 4.6	0.5 2.85	Watts mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	5.0 28.6	1.8 10.6	Watts mW/°C
Operating and Storage Junction Temperature Range	TJ, Tstg	- 65 to	°C	

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	2N3019 2N3020	2N3700	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	217	350	°C/W
Thermal Resistance, Junction to Case	$R_{\theta}JC$	35	97	°C/W

# 2N3019\* 2N3020

CASE 79-04, STYLE 1 TO-39 (TO-205AD)





2N3700\*

CASE 22-03, STYLE 1 TO-18 (TO-206AA)



**GENERAL TRANSISTORS** 

NPN SILICON

★2N3019 and 2N3700 are Motorola designated preferred devices.

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS		-		
Collector-Emitter Breakdown Voltage(1) (IC = 30 mAdc, IB = 0)	V(BR)CEO	80	-	Vdc
Collector-Base Breakdown Voltage (I <sub>C</sub> = 100 μAdc, I <sub>E</sub> = 0)	V <sub>(BR)</sub> CBO	140	_	Vdc
Emitter-Base Breakdown Voltage $(I_E = 100 \ \mu Adc, I_C = 0)$	V(BR)EBO	7.0	_	Vdc
Collector Cutoff Current (V <sub>CB</sub> = 90 Vdc, I <sub>E</sub> = 0) (V <sub>CB</sub> = 90 Vdc, I <sub>E</sub> = 0, $T_A$ = +150°C)	ІСВО	_	0.01	μAdc
Emitter Cutoff Current (VEB = 5.0 Vdc, I <sub>C</sub> = 0)	IEBO	_	0.010	μAdc

### **ON CHARACTERISTICS**

DC Current Gain		hFE			_
(I <sub>C</sub> = 0.1 mAdc, V <sub>CE</sub> = 10 Vdc)	2N3700, 2N3019	'-	50	_	
	2N3020		30	100	
$(I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc})(1)$	2N3700, 2N3019		90	_	
	2N3020		40	120	
$\{I_C = 150 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}\}(1)$	2N3700, 2N3019		100	300	
	2N3020	1	40	120	
$(I_C = 150 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, T_C = -55^{\circ}\text{C})(1)$	2N3700, 2N3019		40	_	
$(I_C = 500 \text{ mAdc}, V_{CE} = 10 \text{ Vdc})(1)$	2N3700, 2N3019		50		
	2N3020		30	100	
$(I_C = 1.0 \text{ Adc}, V_{CE} = 10 \text{ Vdc})(1)$	All Types		15	_	
Collector-Emitter Saturation Voltage(1)		V <sub>CE(sat)</sub>			Vdc
(IC = 150 mAdc, IB = 15 mAdc)				0.2	
(I <sub>C</sub> = 500 mAdc, I <sub>B</sub> = 50 mAdc)			_	0.5	
Base-Emitter Saturation Voltage(1)		V <sub>BE(sat)</sub>	_	1.1	Vdc
(IC = 150 mAdc, IB = 15 mAdc)					

#### **SMALL-SIGNAL CHARACTERISTICS**

Current-Gain — Bandwidth Product		fT		ì	MHz
$(i_C = 50 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 20 \text{ MHz})$	2N3020		80	_	
	2N3019, 2N3700	1	100	400	

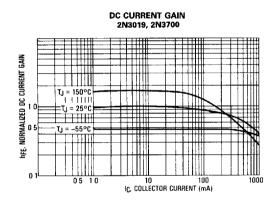
#### 2N3019 2N3020 2N3700

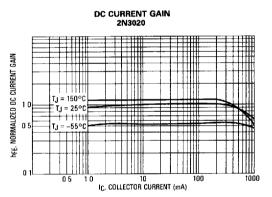
ELECTRICAL CHARACTERISTICS (continued) (TA = 25°C unless otherwise noted.)

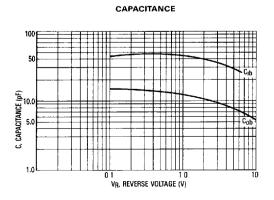
Characteristic		Symbol	Min	Max	Unit
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)		C <sub>obo</sub>	_	12	pF
Input Capacitance (VEB = $0.5$ Vdc, IC = $0$ , f = $1.0$ MHz		C <sub>ibo</sub>	_	60	рF
Small-Signal Current Gain $(I_C = 1.0 \text{ mAdc}, V_{CE} = 5.0 \text{ Vdc}, f = 1.0 \text{ kHz})$	2N3700, 2N3019 2N3020	h <sub>fe</sub>	80 30	400 200	_
Collector Base Time Constant (I <sub>E</sub> = 10 mAdc, V <sub>CB</sub> = 10 Vdc, f = 79.8 MHz)	2N3019, 2N3020 2N3700	rb′C <sub>C</sub>	— 15	400 400	ps
Noise Figure (I <sub>C</sub> = 100 $\mu$ Adc, V <sub>CE</sub> = 10 Vdc, R <sub>S</sub> = 1.0 k ohms, f = 1.0 kHz)	2N3019, 2N3700	NF	_	4	dB

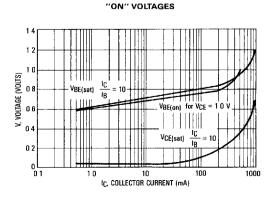
<sup>(1)</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  1.0%.

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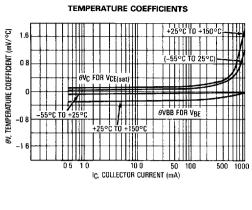


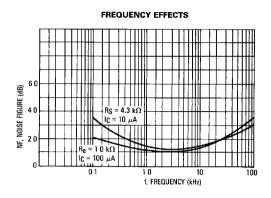




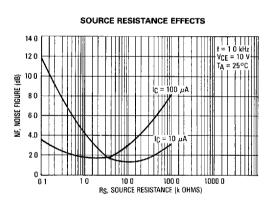


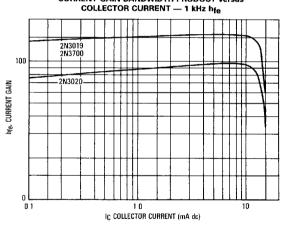
### 2N3019 2N3020 2N3700

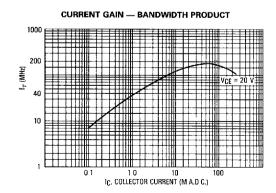


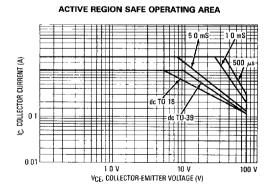


**CURRENT GAIN BANDWIDTH PRODUCT versus** 









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